

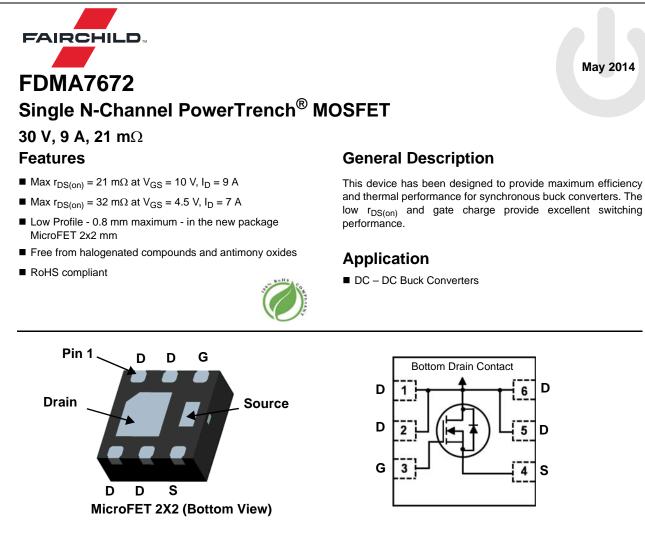
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# **ON Semiconductor**®

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## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>DSS</sub>	Drain to Source Voltage			30	V
V <sub>GSS</sub>	Gate to Source Voltage			±20	V
ID	Drain Current -Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	9	
	-Pulsed			24	— A
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.4	14/
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1b)	0.9	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	6.9	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 52	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1	o) 145	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
672	FDMA7672	MicroFET 2x2	7 "	8 mm	3000 units

FDMA7672 Single N-Channel Power Trench<sup>®</sup> MOSFET

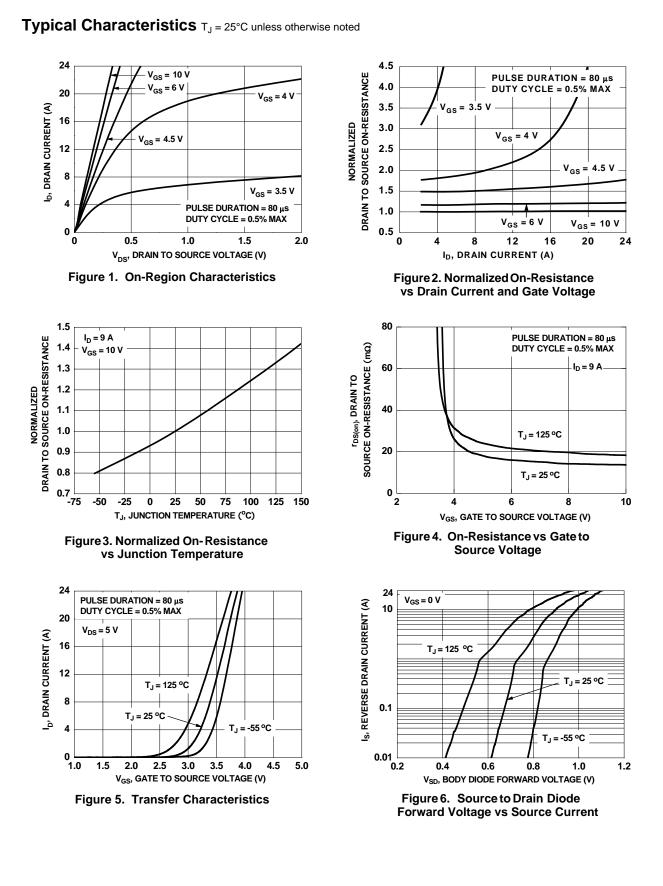
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<sup>®</sup> MOSFET

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	30			V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		16		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$ 1.		2.1	3.0	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-6		mV/°C
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9 A		14	21	
	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \ I_D = 7 \text{ A}$		20	32	mΩ
		$V_{GS} = 10 \text{ V}, \ \text{I}_{D} = 9 \text{ A}, \ \text{T}_{J} = 125 \ ^{\circ}\text{C}$		19	28	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 9 A		35		S
Dvnamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			570	760	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V$		195	260	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0 MHz		25	40	pF
R <sub>q</sub>	Gate Resistance			1.5		Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			6	12	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 9 A		2	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		14	25	ns
t <sub>f</sub>	Fall Time			2	10	ns
Qg	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		9.3	13	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 15 V,$		4.4	6	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 9 A		1.9		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			1.5		nC
Drain-Sou	arce Diode Characteristics					
I <sub>S</sub>	Maximum Continuous Drain-Source Diod	de Forward Current			2	Α
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.8	1.2	V
t <sub>rr</sub>	Reverse Recovery Time			18	32	ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = 9 A, di/dt = 100 A/μs		5	10	nC

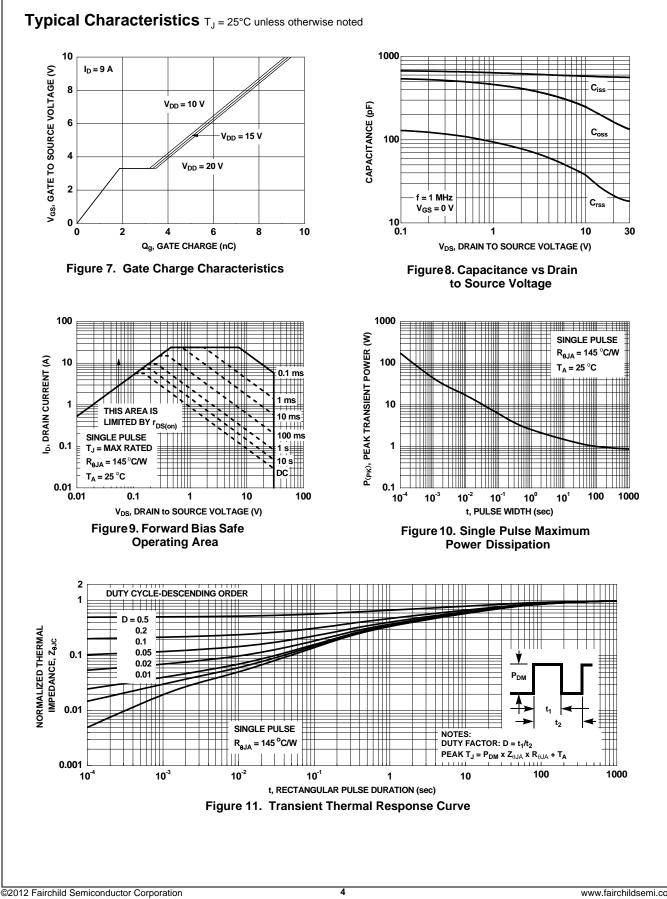
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

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FDMA7672 Single N-Channel Power Trench<sup>®</sup> MOSFET

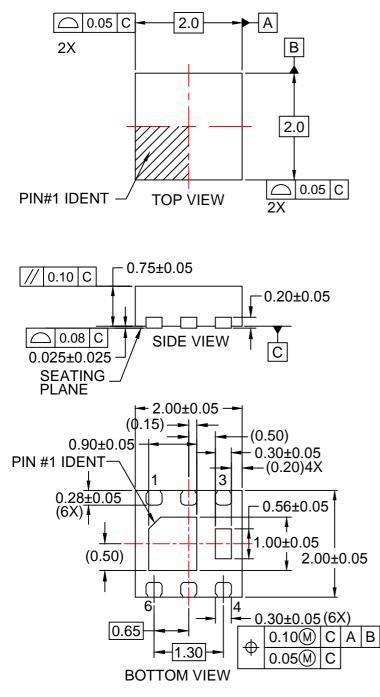


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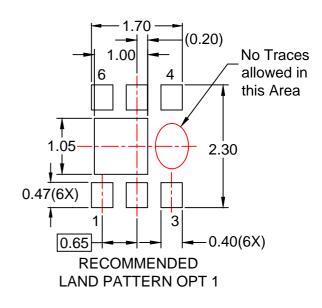
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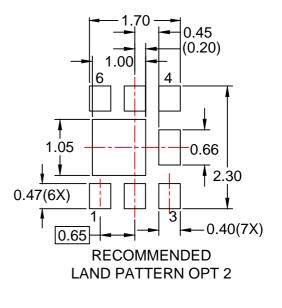
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